



I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:

Assistant Commissioner for Patents  
U. S. Patent and Trademark Office  
Washington, D.C. 20231

On September 13, 2002

TOWNSEND and TOWNSEND and CREW LLP

By: Sara B. McPeak

Sara B. McPeak

Attorney Docket No.: 00939-073600

#21/Response  
9.28.02  
C. Moore  
PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of:

Sang Young Kim et al.

Application No.: 09/434,736

Filed: November 2, 1999

For: METHOD FOR FILLING  
CONTACT HOLES WITH METAL BY  
TWO-STEP DEPOSITION

Art Unit: 2829

Examiner: Evan T. Pert

RESPONSE

Assistant Commissioner for Patents  
U. S. Patent and Trademark Office  
Washington, D.C. 20231

Sir:

In response to the Office Action mailed July 15, 2002, and as requested by the Examiner in that Office Action, enclosed is the Original Ribbon Patent No. 5,683,938.

**IN THE DRAWINGS:**

Also as requested by the Examiner in the Office Action, enclosed herewith are 3 sheets of formal drawings (Figs. 1A-2D) and a *Letter to Official Draftsperson*.

RECEIVED  
SEP 20 2002  
TECHNOLOGY CENTER 2800